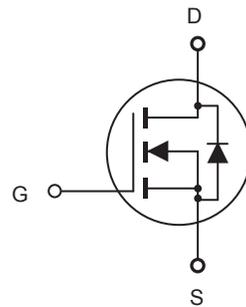


N-Channel Enhancement Mode Field Effect Transistor

FEATURES

- 650V, 6A, $R_{DS(ON)} = 1.45\Omega$ @ $V_{GS} = 10V$.
- Super high dense cell design for extremely low $R_{DS(ON)}$.
- High power and current handling capability.
- Lead free product is acquired.
- TO-251 & TO-252 package.



ABSOLUTE MAXIMUM RATINGS $T_C = 25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Limit	Units
Drain-Source Voltage	V_{DS}	650	V
Gate-Source Voltage	V_{GS}	± 30	V
Drain Current-Continuous @ $T_C = 25^\circ\text{C}$ @ $T_C = 100^\circ\text{C}$	I_D	6	A
		3.7	A
Drain Current-Pulsed ^a	I_{DM}	24	A
Maximum Power Dissipation @ $T_C = 25^\circ\text{C}$ - Derate above 25°C	P_D	107	W
		0.85	W/ $^\circ\text{C}$
Repetitive Avalanche Energy	E_{AR}	0.38	mJ
Single Pulsed Avalanche Energy ^e	E_{AS}	216	mJ
Single Pulsed Avalanche Current ^e	I_{AS}	6	A
Operating and Store Temperature Range	T_J, T_{stg}	-55 to 175	$^\circ\text{C}$

Thermal Characteristics

Parameter	Symbol	Limit	Units
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	1.4	$^\circ\text{C/W}$
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	50	$^\circ\text{C/W}$



CED07N65A/CEU07N65A

Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Test Condition	Min	Typ	Max	Units
Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS} = 0V, I_D = 250\mu A$	650			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 650V, V_{GS} = 0V$			1	μA
Gate Body Leakage Current, Forward	I_{GSSF}	$V_{GS} = 30V, V_{DS} = 0V$			100	nA
Gate Body Leakage Current, Reverse	I_{GSSR}	$V_{GS} = -30V, V_{DS} = 0V$			-100	nA
On Characteristics^b						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS} = V_{DS}, I_D = 250\mu A$	2		4	V
Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 3A$		1.22	1.45	Ω
Gate input resistance	R_g	$f=1\text{MHz}, \text{open Drain}$		1.5		Ω
Dynamic Characteristics^c						
Input Capacitance	C_{iss}	$V_{DS} = 25V, V_{GS} = 0V, f = 1.0 \text{ MHz}$		1410		pF
Output Capacitance	C_{oss}			115		pF
Reverse Transfer Capacitance	C_{rss}			15		pF
Effective output capacitance ^f energy related	$C_{o(er)}$	$V_{GS} = 0V, V_{DS} = 0V \text{ to } 480V$		42		pF
Effective output capacitance ^g time related	$C_{o(tr)}$			38.5		pF
Switching Characteristics^c						
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = 300V, I_D = 6A, V_{GS} = 10V, R_{GEN} = 25\Omega$		26	52	ns
Turn-On Rise Time	t_r			58	116	ns
Turn-Off Delay Time	$t_{d(off)}$			85	170	ns
Turn-Off Fall Time	t_f			63	126	ns
Total Gate Charge	Q_g	$V_{DS} = 480V, I_D = 6A, V_{GS} = 10V$		28	36	nC
Gate-Source Charge	Q_{gs}			6		nC
Gate-Drain Charge	Q_{gd}			9		nC
Drain-Source Diode Characteristics and Maximum Ratings						
Drain-Source Diode Forward Current	I_S				5	A
Drain-Source Diode Forward Voltage ^b	V_{SD}	$V_{GS} = 0V, I_S = 5A$			1.5	V
Notes : a. Repetitive Rating : Pulse width limited by maximum junction temperature. b. Device Mounted on FR4 Board, $t < 10 \text{ sec}$. c. Pulse Test : Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$. d. Guaranteed by design, not subject to production testing. e. $L = 12\text{mH}, I_{AS} = 6A, V_{DD} = 50V, R_G = 25\Omega$, Starting $T_J = 25 \text{ C}$. f. $C_{o(er)}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{ds} is rising from 0 to 80% V_{dss} . g. $C_{o(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{ds} is rising from 0 to 80% V_{dss} .						

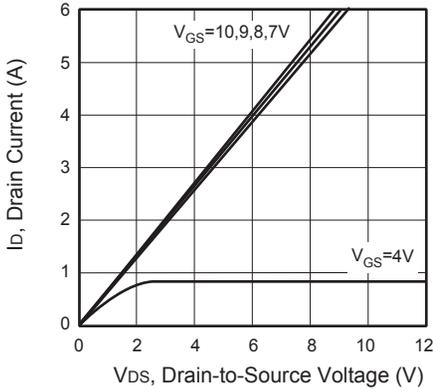


Figure 1. Output Characteristics

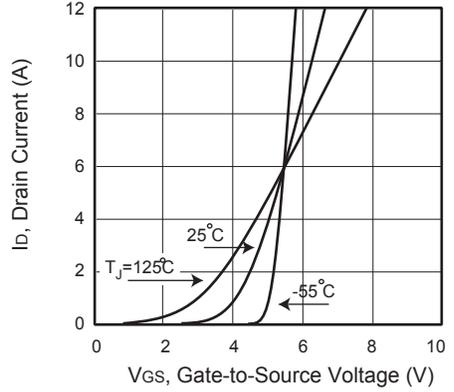


Figure 2. Transfer Characteristics

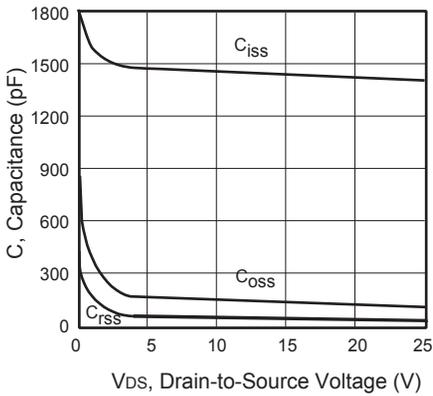


Figure 3. Capacitance

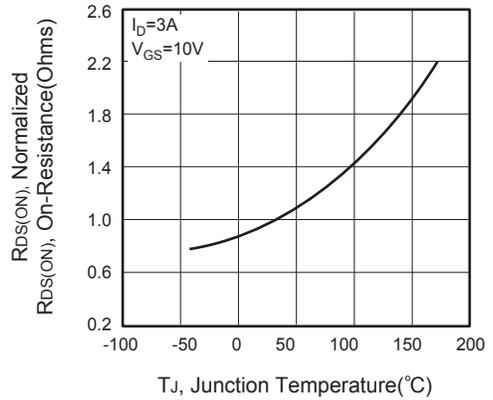


Figure 4. On-Resistance Variation with Temperature

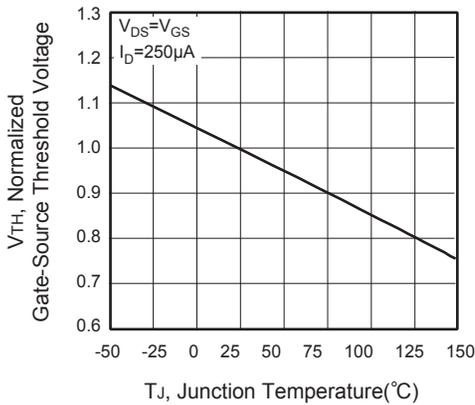


Figure 5. Gate Threshold Variation with Temperature

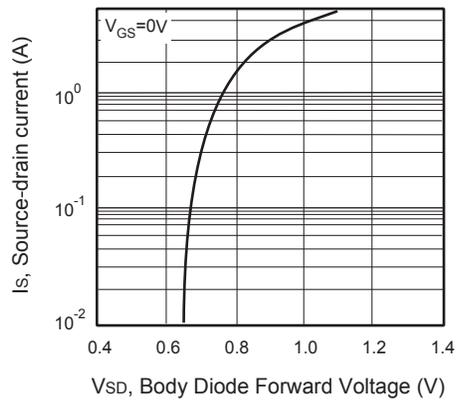


Figure 6. Body Diode Forward Voltage Variation with Source Current

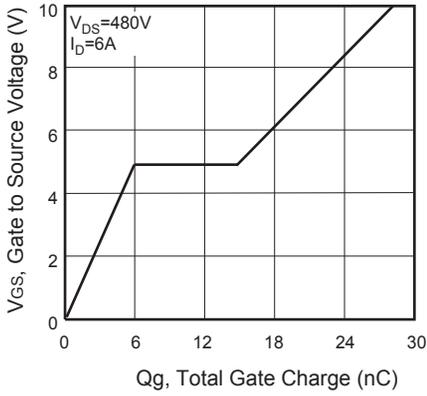


Figure 7. Gate Charge

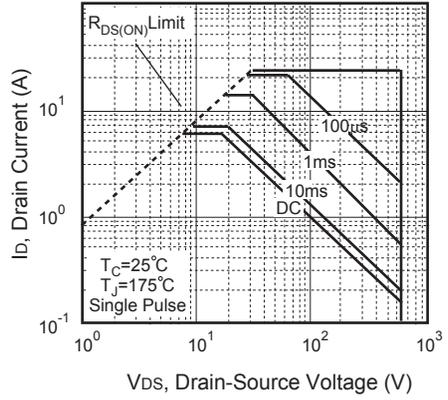


Figure 8. Maximum Safe Operating Area

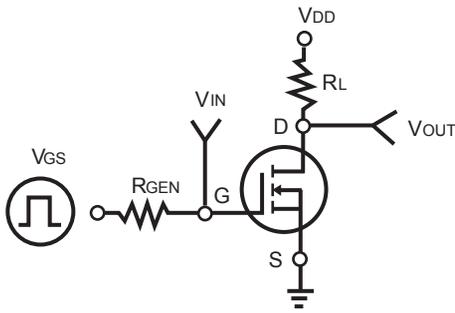


Figure 9. Switching Test Circuit

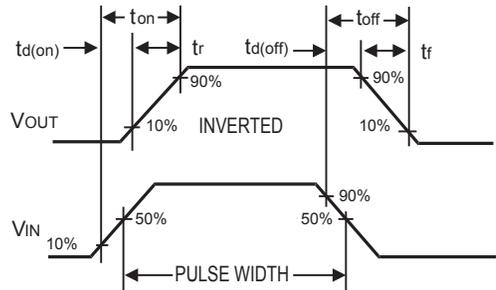


Figure 10. Switching Waveforms

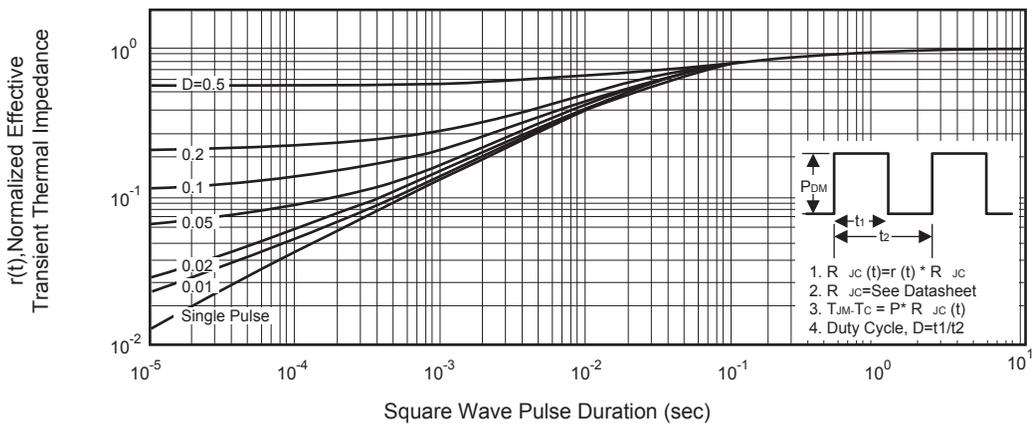


Figure 11. Normalized Thermal Transient Impedance Curve